

HYLINTECH HLMX93X Series Modules User Manual

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HYLINTECH HLMX93X Series Modules



Overview

HLMx93x series modules are developed based on the digital baseband chip SX1302 with a mechanical definition of the Mini PCIe interface and provide SPI interface.

HLMx93x can be applied to LoRaWAN gateways, private LoRa network gateways, and can also be used to develop LoRa network analysis tools. In addition, SX1302 has lower power consumption, higher data throughput, and better cost compared to its predecessor.

Key Features

- Supports multiple bands
- SPI Interface
- (G)FSK demodulator
- High precision TCXO clock source

Typical Specification

• operating range from -40 to +85° C

• Power supply voltage range: 3.0V-3.6V

• Antenna interface: IPEX-1

Usage

- LoRa/LoRaWAN Gateway
- · LoRa Network Analysis Tool

Model Information

*Model	Tx Band	Max Power	Rx Band	LBT	MOQ
HLM7931	490-510MHz	22dBm	470-510MHz	Not Support	3000
HLM7932	470-510MHz	22dBm	470-510MHz	Support	1000
HLM9931	863-928MHz	27dBm	863-928MHz	Support	EOL
HLM9932	863-928MHz	27dBm	863-928MHz	Support	1000
HLM9933	902-928MHz	28dBm	902-928MHz	Support	1000
HLM8934	863-870MHz	27dBm	863-870MHz	Support	1000
HLM5934	902-928MHz	27dBm	902-928MHz	Support	1000
HLM9934	TBD	27dBm	TBD	Support	_
HLM8834	TBD	21dBm	TBD	Support	_
HLM5834	TBD	21dBm	TBD	Support	_
HLM9834	TBD	21dBm	TBD	Support	_
HLM9953	TBD	27dBm	TBD	Support	_

^{*}The full model number will contain the "-xxx" suffix to distinguish the packaging method, screen printing information, etc., such as HLM5934-P01.

Specifications

Table.2-1.Absolute.Minimum.and.Maximum.Ratings

Name	Value			Description
Name	Min	Max	Unit	Description
Power Supply	-0.5	+3.9	V	
Storage temperature	-40	+125	°C	
Peak reflow temperature	_	260	°C	

Name		Value				Description
		Min	Тур	Max	Unit	The transmitting power decreases when
Power Supply		3.0	3.3	3.6	V	the supply voltage is below 3.0V
Operating temperature		-40	_	85	°C	
Frequency Stability			2		ppm	25°C
	HLM7931	20	21	22	dBm	@490MHz~510MHz
	HLM7932	20	21	22	dBm	@470MHz~510MHz
	HLM9932	25	26	27	dBm	@863MHz~928MHz
			1	1	1	1

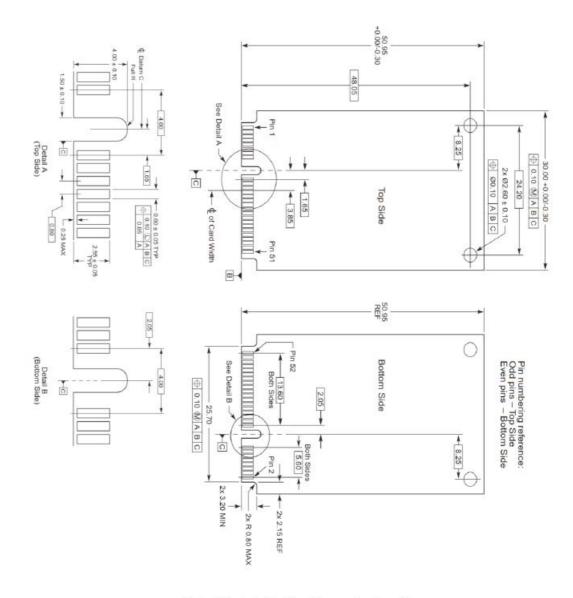
	HLM9933	20	24	28	dBm	@902MHz~928MHz
Tx Po						-
	HLM8934	25	26	27	dBm	@863MHz~870MHz
w er	HLM5934	23	25	27	dBm	@902MHz~928MHz
*	HLM9934				dBm	TBD
	HLM8834				dBm	TBD
	HLM5834				dBm	TBD
	HLM9834				dBm	TBD
	HLM9953				dBm	TBD
	HLM7931		-127		dBm	SF7BW125CR4/5@470MHz~510MHz
	HLM7932		-127		dBm	SF7BW125CR4/5@470MHz~510MHz
	HLM9932		-127		dBm	SF7BW125CR4/5@863MHz~928MHz
Rx	HLM9933		-127		dBm	SF7BW125CR4/5@863MHz~928MHz
Se ns	HLM8934		-125		dBm	SF7BW125CR4/5@863MHz~870MHz
iti	HLM5934		-126		dBm	SF7BW125CR4/5@902MHz~928MHz
vit y*	HLM9934				dBm	TBD
*	HLM8834				dBm	TBD
	HLM5834				dBm	TBD
	HLM9834				dBm	TBD
	HLM9953				dBm	TBD
Inte	rface Packaging	Mini PCle				
Digi	ital Interface	SPI				_
Dim	nension (mm)	30×50.95×3				
dim	ensional accuracy l	GB/T1804-C				
W r a	Tseist utnder nomfiin	wtempePratRu=re %and 2vBoyltage conditions.			Boyltage	

 $^{{}^{\}star}\text{CW.Test.under.nominal.temperature.and.voltage.conditions.}$

Package and Pin Connections

Package

^{**}Sensitivity.is.specified.with.a.PER=1%,.32Bytes,.all.under.nominal.temperature.and.voltage.conditions.



Pic 3-1 Module Outline Dimension Drawing

Pin Connections

Pin Number	Pin Name	Description
1	NC	NC
2	NC/5V	NC
3	NC	NC
4	GND	
5	NC	NC
6	GPIO[9]	SX1302's GPIO[9] Pin
7	NC	NC
8	NC	NC
9	GND	
10	NC	NC
11	NC	NC

12 NC NC 13 NC NC 14 NC NC 15 GND NC 16 NC/Power_EN HLM7931 NC 17 SCK SX1302 and SX126x's SCK Pin 18 GND MISO SX1302 and SX126x's MISO Pin 20 NC NC 21 GND NC 22 RESET SX1302's RESET Pin, High level reset 23 MOSI HLM7931 SX1302 and SX126x's MOSI Pin 24 NC/LBT_BUSY NC Others SX126x 's BUSY Pin 25 CSN SX1302's CSN Pin 26 GND SX1302's CSN Pin 28 NC/LBT_DIO2 HLM7931 NC 29 GND SX126x's DIO2 Pin 30 SCL Temperature Sensor ,SSTS751 31 PPS SX1302's PPS Pin 32 SDA Temperature Sensor ,SSTS751		I				
14 NC NC 15 GND HLM7931 NC 16 NC/Power_EN HLM7931 NC 17 SCK SX1302 and SX126x's SCK Pin 18 GND SX1302 and SX126x's MISO Pin 19 MISO SX1302 and SX126x's MISO Pin 20 NC NC 21 GND SX1302's RESET Pin, High level reset 23 MOSI HLM7931 SX1302 and SX126x's MOSI Pin 24 NC/LBT_BUSY NC Others SX126x's BUSY Pin 25 CSN SX1302's CSN Pin 26 GND 27 GND 28 NC/LBT_DIO2 HLM7931 NC Others SX126x's DIO2 Pin 29 GND 30 SCL Temperature Sensor ,SSTS751 31 PPS SX1302's PPS Pin	12	NC	NC			
15	13	NC	NC			
HLM7931 NC	14	NC	NC			
16 NC/Power_EN Others Power Enable Pin 17 SCK SX1302 and SX126x's SCK Pin 18 GND 19 MISO SX1302 and SX126x's MISO Pin 20 NC NC 21 GND RESET 22 RESET SX1302's RESET Pin, High level reset 23 MOSI HLM7931 SX1302 and SX126x's MOSI Pin 24 NC/LBT_BUSY NC Others SX126x 's BUSY Pin 25 CSN SX1302's CSN Pin SX126x 's BUSY Pin 26 GND HLM7931 NC 27 GND HLM7931 NC 28 NC/LBT_DIO2 Others SX126x's DIO2 Pin 29 GND 30 SCL Temperature Sensor ,SSTS751 31 PPS SX1302's PPS Pin	15	GND				
Others	10	NO/Davies EN	HLM7931	NC		
18	16	NC/Power_EN	Others	Power Enable Pin		
19 MISO SX1302 and SX126x's MISO Pin 20 NC NC 21 GND 22 RESET SX1302's RESET Pin, High level reset 23 MOSI HLM7931 SX1302 and SX126x's MOSI Pin 24 NC/LBT_BUSY Others SX126x 's BUSY Pin 25 CSN SX1302's CSN Pin 26 GND 27 GND 28 NC/LBT_DIO2 HLM7931 NC Others SX126x's DIO2 Pin 29 GND 30 SCL Temperature Sensor ,SSTS751 31 PPS SX1302's PPS Pin	17	SCK	SX1302 and SX12	26x's SCK Pin		
20 NC NC 21 GND 22 RESET SX1302's RESET Pin, High level reset 23 MOSI HLM7931 SX1302 and SX126x's MOSI Pin 24 NC/LBT_BUSY NC Others SX126x 's BUSY Pin 25 CSN SX1302's CSN Pin 26 GND 27 GND 28 NC/LBT_DIO2 HLM7931 NC Others SX126x's DIO2 Pin 29 GND 30 SCL Temperature Sensor ,SSTS751 31 PPS SX1302's PPS Pin	18	GND				
21 GND 22 RESET SX1302's RESET Pin, High level reset 23 MOSI HLM7931 SX1302 and SX126x's MOSI Pin 24 NC/LBT_BUSY Others SX126x 's BUSY Pin 25 CSN SX1302's CSN Pin 26 GND 27 GND 28 NC/LBT_DIO2 Others SX126x's DIO2 Pin PNC Others SX126x's DIO2 Pin SX126x's DIO2 Pin 30 SCL Temperature Sensor ,SSTS751 31 PPS SX1302's PPS Pin	19	MISO	SX1302 and SX12	26x's MISO Pin		
RESET SX1302's RESET Pin, High level reset	20	NC	NC			
23 MOSI HLM7931 SX1302 and SX126x's MOSI Pin 24 NC/LBT_BUSY Others SX126x 's BUSY Pin 25 CSN SX1302's CSN Pin 26 GND 27 GND 28 NC/LBT_DIO2 HLM7931 NC Others SX126x's DIO2 Pin 29 GND 30 SCL Temperature Sensor ,SSTS751 31 PPS SX1302's PPS Pin	21	GND				
24 NC/LBT_BUSY NC 25 CSN SX1302's CSN Pin 26 GND 27 GND 28 NC/LBT_DIO2 HLM7931 NC Others SX126x's DIO2 Pin 29 GND 30 SCL Temperature Sensor ,SSTS751 31 PPS SX1302's PPS Pin	22	RESET	SX1302's RESET Pin, High level reset			
24 NC/LBT_BUSY Others SX126x 's BUSY Pin 25 CSN SX1302's CSN Pin 26 GND 27 GND 28 NC/LBT_DIO2 HLM7931 NC Others SX126x's DIO2 Pin 29 GND 30 SCL Temperature Sensor ,SSTS751 31 PPS SX1302's PPS Pin	23	MOSI	HLM7931 SX1302 and SX126x's MOSI Pin			
Others SX126x 's BUSY Pin 25 CSN SX1302's CSN Pin 26 GND 27 GND 28 NC/LBT_DIO2 HLM7931 NC Others SX126x's DIO2 Pin 29 GND 30 SCL Temperature Sensor ,SSTS751 31 PPS SX1302's PPS Pin	24	NC/LDT DUCY		NC		
26 GND 27 GND 28 NC/LBT_DIO2 HLM7931 NC NC SX126x's DIO2 Pin 29 GND 30 SCL Temperature Sensor ,SSTS751 31 PPS SX1302's PPS Pin	24	NO/LD1_DOO1	Others	SX126x 's BUSY Pin		
27 GND 28 NC/LBT_DIO2 HLM7931 NC NC NC/LBT_DIO2 Others SX126x's DIO2 Pin 29 GND 30 SCL Temperature Sensor ,SSTS751 31 PPS SX1302's PPS Pin	25	CSN	SX1302's CSN Pin			
28 NC/LBT_DIO2 HLM7931 NC Others SX126x's DIO2 Pin 29 GND 30 SCL Temperature Sensor ,SSTS751 31 PPS SX1302's PPS Pin	26	GND				
28 NC/LBT_DIO2 Others SX126x's DIO2 Pin 29 GND 30 SCL Temperature Sensor ,SSTS751 31 PPS SX1302's PPS Pin	27	GND				
Others SX126x's DIO2 Pin 29 GND 30 SCL Temperature Sensor ,SSTS751 31 PPS SX1302's PPS Pin	20	NC/LDT DIO	HLM7931	NC		
30 SCL Temperature Sensor ,SSTS751 31 PPS SX1302's PPS Pin	20	NO/LB1_DIO2	Others	SX126x's DIO2 Pin		
31 PPS SX1302's PPS Pin	29	GND				
	30	SCL	Temperature Sensor ,SSTS751			
32 SDA Temperature Sensor ,SSTS751	31	PPS	SX1302's PPS Pin			
	32	SDA	Temperature Sensor ,SSTS751			

33	NC	NC	
34	GND		
35	GND		
36	NC	NC	
37	GND		
38	NC	NC	
39	VCC	3.3V Power	
40	GND		
41	VCC	3.3V Power	
42	NC	NC	
43	GND		
44	NC/LBT_NSS	HLM7931	NC
44	NO/LDT_NSS	Others	SX126x's NSS Pin
45	NC	HLM7931	NC NC
46	NC/LBT_DIO1		
40	NO/LD1_DIG1	Others	SX126x's DIO1 Pin
47	NC	HLM7931	NC NC
48	NC/LBT_RST		
10	No, EBT_NOT	Others	SX126x's NRESET Pin, Low level reset
49	NC	NC	
50	GND		
51	GPIO[4]	HLM7931 S	SX1302's GPIO[4] Pin
52	NC/VCC		NC
0_	110/100	Others	3.3V Power

Basic Usage

Application Circuit

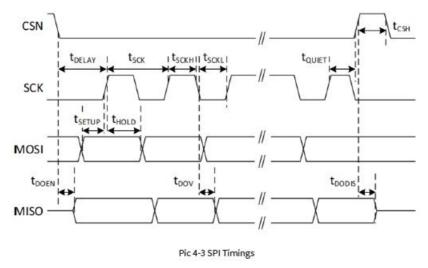
When using this module, the main attention is paid to the handling of power ripple.HLM7 932,HLM9931,HLM9932,HLM9933,HLM5934,HLM8934's Pin2 is NC.

Layout

- Try to give this module a separate power supply and ensure that the power ripple is as small as possible.
- If you use IPEX to connect to an external antenna, take care to consider the lightning protection design of the external antenna.
- Stay away from high voltage circuits, and high-frequency switching circuits.

SPI Timings

Users communicate with SX1302, the main chip of this module, through SPI interface, and achieve control and access to SX1302 by accessing SX1302 registers. For specific usage, you can refer to the SX1302 information released by SEMTECH's official website



FCC Statement

Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:

- 1. This device may not cause harmful interference, and
- 2. This device must accept any interference received, including interference that may cause undesired operation.

Note: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

RF Exposure Statement

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20cm between the radiator and your body.

FCC Label Instructions

If using a permanently affixed label, the modular transmitter must be labeled with its own FCC identification number, and, if the FCC identification number is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording such as the following:

"Contains FCC ID: 2A4G5-HLM9933".

Any similar wording that expresses the same meaning may be used. The Grantee may either provide such a label, an example of which must be included in the application for equipment authorization, or, must provide

adequate instructions along with the module which explain this requirement.

OEM Guidance

1. Applicable FCC rules

This device complies with part 15.247 of the FCC Rules.

2. The specific operational use conditions

This module can be used in IoT devices. The input voltage to the module is nominally 3.3 V DC. The operational ambient temperature of the module is -40 $^{\circ}$ C $^{\sim}$ 85 $^{\circ}$ C. the external antenna is allowed, such as monopole antenna.

- 3. Limited module procedures N/A
- 4. Trace antenna design N/A
- 5. RF exposure considerations

The equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20cm between the radiator and your body. equipment built into a host as a portable usage, the additional RF exposure evaluation may be required as specified by 2.1093.

6. Antenna

Antenna type: Monopole antenna; Peak antenna gain: 2.44 dBi

- 7. Label and compliance information An exterior label on OEM's end product can use wording such as the following: "Contains Transmitter Module FCC ID: 2A4G5-HLM9933" or "Contains FCC ID: 2A4G5-HLM9933"
- 8. Information on test modes and additional testing requirements The modular transmitter has been fully tested by the module grantee on the required number of channels, modulation types, and modes, it should not be necessary for the host installer to re-test all the available transmitter modes or settings. It is recommended that the host product manufacturer, installing the modular transmitter, perform some investigative measurements to confirm that the resulting composite system does not exceed the spurious emissions limits or band edge limits (e.g., where a different antenna may be causing additional emissions).

The testing should check for emissions that may occur due to the intermixing of emissions with the other transmitters, digital circuitry, or due to physical properties of the host product (enclosure). This investigation is especially important when integrating multiple modular transmitters where the certification is based on testing each of them in a stand-alone configuration. It is important to note that host product manufacturers should not assume that because the modular transmitter is certified that they do not have responsibility for final product compliance. If the investigation indicates a compliance concern the host product manufacturer is obligated to mitigate the issue. Host products using a modular transmitter are subject to all the applicable individual technical rules as well as to the general conditions of operation in Sections 15.5, 15.15, and 15.29 to not cause interference. The operator of the host product will be obligated to stop operating the device until the interference have been corrected.

Additional testing, Part 15 Sub part B disclaimer

The final host/module combination need to be evaluated against the FCC Part 15B criteria for unintentional radiators in order to be properly authorized for operation as a Part 15 digital device.

The host integrator installing this module into their product must ensure that the final composite product complies with the FCC requirements by a technical assessment or evaluation to the FCC rules, including the transmitter operation and should refer to the guidance in KDB 996369. For host products with certified modular transmitters, the frequency range of investigation of the composite system is specified by rule in Sections 15.33(a)(1) through (a)(3), or the range applicable to the digital device, as shown in Section 15.33(b)(1), whichever is the higher frequency range of investigation When testing the host product, all the transmitters must be operating. The transmitters can be enabled by using publicly-available drivers and turned on, so the transmitters are active. In

certain conditions, it might be appropriate to use a technology-specific call box (test set) where accessory 50 devices or drivers are not available.

When testing for emissions from the unintentional radiator, the transmitter shall be placed in the receive mode or idle mode, if possible. If receive mode only is not possible then, the radio shall be passive (preferred) and/or active scanning. In these cases, this would need to enable activity on the communication BUS (i.e., PCIe, SDIO, USB) to ensure the unintentional radiator circuitry is enabled. Testing laboratories may need to add attenuation or filters depending on the signal strength of any active beacons (if applicable) from the enabled radio(s). See ANSI C63.4, ANSI C63.10 and ANSI C63.26 for further general testing details. The product under test is set into a link/association with a partnering device, as per the normal intended use of the product. To ease testing, the product under test is set to transmit at a high duty cycle, such as by sending a file or streaming some media content.

Documents / Resources



HYLINTECH HLMX93X Series Modules [pdf] User Manual

HLM9933, 2A4G5-HLM9933, 2A4G5HLM9933, HLMX93X Series Modules, HLMX93X Series, Modules

Manuals+.